












# Board Stack Report

Stack Up		Layer Stack			
Layer	Board Layer Stack	Name	Material	Thickness	Constant
1		Top Paste			
2		Top Overlay			
3		Top Solder	Solder Resist	0.010mm	3.5
4		Top Layer	Copper	0.036mm	
5		Dielectric1	FR-4	1.000mm	4.8
6		s	Copper	0.036mm	
7		Dielectric2	FR-4	0.320mm	4.8
8		GND	Copper	0.036mm	
9		Dielectric3	FR-4	0.320mm	4.8
10		Bottom Layer	Copper	0.036mm	
11		Bottom Solder	Solder Resist	0.010mm	3.5
12		Bottom Overlay			
13		Bottom Paste			
	Height : 1.803mm				